Attorney's Docket No.:
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## DECLARATION, POWER OF ATTORNEY AND PETITION

l (We), the	undersigned	inventor(s), hereby declare that:			
My residen	ce, post offic	ce address and citizenship are as state	d below next to my	name.	
		m (we are) the original, first, and jo			
		claimed and for which a patent is sou			
		IT FOR CONTROLLING PLANT D			
		C DACILLIC			
the specific	ation of whic				
	is attached hereto.				
	was filed or	1		as	
		Serial No.			
		ed on		•	
was filed as PCT international application					
		PCT/JP2005/003094			
	on	February 18, 2005		•	
		ended under PCT Article 19		.5	
	on		_(if applicable).		
			— ( FF)·		

I (We) hereby state that I (We) have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above; that I (We) do not know and do not believe that this invention was ever known or used before my invention or discovery thereof, or patented or described in any printed publication in any country before my invention or discovery thereof, or more than one year prior to this application, or in public use or on sale in the United States for more than one year prior to this application; that this invention or discovery has not been patented or made the subject of an inventor's certificate in any country foreign to the United States on an application filed by me or my legal representatives or assigns more than twelve months before this application.

I (We) acknowledge the duty to disclose information known to be material to the patentability of this application as defined in Section 1.56 of Title 37 Code of Federal Regulations.

I (We) hereby claim foreign priority benefits under Section 119(a)-(d) of Title 35 United States Code, of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Application No. 2004-055059 2004-216083	Country Japan Japan	Filing date February 27, 2004 July 23, 2004	Priority claimed  ■ Yes □ No ■ Yes □ No □ Yes □ No □ Yes □ No				
I hereby claim the b United States applica			5 United States Code, of any				
(Application Number	r)	(Filing Date	)				
(Application Number	r)	(Filing Date	)				
I (We) hereby claim the benefit under Section 120 of Title 35 United States Code, of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Section 112 of Title 35 United States Code, I (We) acknowledge the duty to disclose material information as defined in Section 1.56(a) of Title 37 Code of Federal Regulations, which occurred between the filing date of the prior application and national or PCT international filing date of this application:							
Application Serial No	o. Fili	ng Date	Status (pending, patented, abandoned)				

And I (We) hereby appoint: WENDEROTH, LIND & PONACK, L.L.P., CUSTOMER NUMBER 00513

I(We) hereby request that all correspondence regarding this application be sent to the firm of WENDEROTH, LIND & PONACK, L.L.P. whose Post office address is: 2033 K Street, N.W., Suite 800, Washington, D. C. 20006-1021 U.S.A.

I (We) declare further that all statements made herein of my (our) knowledge are true and that all statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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